

# TLV3502A-Q1

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## Functional Safety Failure In Time (FIT) Rates

**Table 1. Component Failure Rates per IEC TR 62380 / ISO 26262 Part 11**

FIT IEC TR 62380 / ISO 26262	FIT (Failures Per 109 Hours)
Total FIT Rate	5
Die FIT Rate	3
Package FIT Rate	2

The failure rate and mission profile information in [Table 1](#) comes from the Reliability data handbook IEC TR 62380 / ISO 26262 part 11:

- Mission Profile: Motor Control from Table 11
- Power dissipation: 100 mW
- Climate type: World-wide Table 8
- Package factor lambda 3 Table 17b
- Substrate Material: FR4
- EOS FIT rate assumed: 0 FIT

**Table 2. Component Failure Rates per Siemens Norm SN 29500-2**

Table	Category	Reference FIT Rate	Reference Virtual TJ
4	CMOS Operational Amp, Comparators and Voltage monitors	8 FIT	45 C

The Reference FIT Rate and Reference Virtual T<sub>J</sub> (junction temperature) in [Table 2](#) come from the Siemens Norm SN 29500-2 tables 1 through 5. Failure rates under operating conditions are calculated from the reference failure rate and virtual junction temperature using conversion information in SN 29500-2 section 4.

## Failure Mode Distribution (FMD)

**Table 3. Die Failure Modes and Distribution**

Die Failure Modes	Failure Mode Distribution (%)
Out open (HIZ)	20%
Out saturate high	25%
Out saturate low	25%
Out functional not in specification	30%